ON Semiconductor

Is Now

Onsemi

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TinyLogic ULP-A 3-Input AND Gate

NC7SV11

The NC7SV11 is a single 3-Input AND Gate in tiny footprint packages. The device is designed to operate for $V_{CC} = 0.9$ V to 3.6 V.

Features

- Designed for 0.9 V to 3.6 V V_{CC} Operation
- 1.7 ns t_{PD} at 3.3 V (Typ)
- Inputs/Outputs Over–Voltage Tolerant up to 3.6 V
- I_{OFF} Supports Partial Power Down Protection
- Source/Sink 24 mA at 3.3 V
- Available in SC-88 and MicroPak[™] Packages
- These Devices are Pb-Free, Halogen Free/BFR Free and are RoHS Compliant

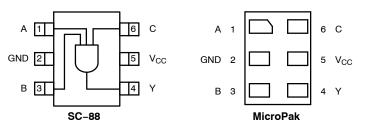


Figure 1. Pinout Diagrams (Top Views)

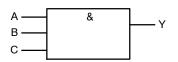


Figure 2. Logic Symbol



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MARKING DIAGRAMS





- = Specific Device Code = 2-Digit Lot Run Traceability Code = 2-Digit Date Code = Assembly Plant Code

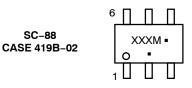


CC

KK

XY

7



- XXX = Specific Device Code
- = Date Code* Μ
- = Pb-Free Package

(Note: Microdot may be in either location) *Date Code orientation and/or position may vary depending upon manufacturing location.

ORDERING INFORMATION

See detailed ordering, marking and shipping information on page 6 of this data sheet.

PIN ASSIGNMENT

Pin	Function
1	А
2	GND
3	В
4	Y
5	V _{CC}
6	С

FUNCTION TABLE (Y = ABC)

	Output		
Α	В	С	Y
Х	Х	L	L
Х	L	Х	L
L	Х	Х	L
Н	Н	Н	Н

H = HIGH Logic Level

L = LOW Logic Level X = Either LOW or HIGH Logic Level

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MAXIMUM RATINGS

Symbol	Characterist	ics	Value	Unit
V _{CC}	DC Supply Voltage		-0.5 to +4.3	V
V _{IN}	DC Input Voltage		-0.5 to +4.3	V
V _{OUT}	DC Output Voltage	Active-Mode (High or Low State) Tri-State Mode (Note 1) Power-Down Mode (V _{CC} = 0 V)	$\begin{array}{c} -0.5 \text{ to } V_{CC} + 0.5 \\ -0.5 \text{ to } +4.3 \\ -0.5 \text{ to } +4.3 \end{array}$	V
I _{IK}	DC Input Diode Current	V _{IN} < GND	-50	mA
I _{OK}	DC Output Diode Current	V _{OUT} < GND	-50	mA
I _{OUT}	DC Output Source/Sink Current		±50	mA
I _{CC} or I _{GND}	DC Supply Current per Supply Pin or Ground	Pin	±50	mA
T _{STG}	Storage Temperature Range		-65 to +150	°C
ΤL	Lead Temperature, 1 mm from Case for 10 S	econds	260	°C
TJ	Junction Temperature Under Bias		+150	°C
θ_{JA}	Thermal Resistance (Note 2)	SC–88 MicroPak	377 154	°C/W
P _D	Power Dissipation in Still Air	SC–88 MicroPak	332 812	mW
MSL	Moisture Sensitivity		Level 1	-
F _R	Flammability Rating	Oxygen Index: 28 to 34	UL 94 V-0 @ 0.125 in	-
V_{ESD}	ESD Withstand Voltage (Note 3)	Human Body Model Charged Device Model	2000 1000	V
I _{Latchup}	Latchup Performance (Note 4)		±100	mA

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.
Applicable to devices with outputs that may be tri-stated.
Measured with minimum pad spacing on an FR4 board, using 10 mm-by-1 inch, 2 ounce copper trace no air flow per JESD51-7.
HBM tested to EIA / JESD22-A114-A. CDM tested to JESD22-C101-A. JEDEC recommends that ESD qualification to EIA/JESD22-A115A (Machine Model) be discontinued.
Tested to EIA/JESD78 Class II.

RECOMMENDED OPERATING CONDITIONS

Symbol	Parameter			Max	Unit
V _{CC}	Positive DC Supply Voltage		0.9	3.6	V
V _{IN}	DC Input Voltage		0	3.6	V
V _{OUT}	DC Output Voltage	Active–Mode (High or Low State) Tri–State Mode (Note 1) Power–Down Mode (V _{CC} = 0 V)	0 0 0	V _{CC} 3.6 3.6	
T _A	Operating Temperature Range		-40	+85	°C
t _r , t _f	Input Transition Rise and Fall Time	$V_{CC}=3.3~V\pm0.3~V$	0	10	ns/V

Functional operation above the stresses listed in the Recommended Operating Ranges is not implied. Extended exposure to stresses beyond the Recommended Operating Ranges limits may affect device reliability.

DC ELECTRICAL CHARACTERISTICS

				Т	T _A = 25°C		T _A = -40°0	C to +85°C	
Symbol	Parameter	Condition	V _{CC} (V)	Min	Тур	Max	Min	Мах	Unit
VIH	High-Level Input		0.9	_	0.5	-	-	-	V
	Voltage		1.1 to 1.3	0.65 x V _{CC}	-	-	0.65 x V _{CC}	-	
			1.4 to 1.6	$0.65 \times V_{CC}$	-	-	$0.65 \times V_{CC}$	-	
			1.65 to 1.95	$0.65 \times V_{CC}$	-	-	$0.65 \times V_{CC}$	-	
			2.3 to <2.7	1.6	-	-	1.6	-	
			2.7 to 3.6	2.0	-	-	2.0	-	
VIL	Low-Level Input		0.9	-	0.5	-	-	-	V
	Voltage		1.1 to 1.3	-	-	$0.35 \times V_{CC}$	-	$0.35 \times V_{CC}$	
			1.4 to 1.6	-	-	$0.35 \times V_{CC}$	-	$0.35 \times V_{CC}$	
			1.65 to 1.95	-	-	$0.35 \times V_{CC}$	-	0.35 x V _{CC}	
			2.3 to <2.7	-	-	0.7	-	0.7	
			2.7 to 3.6	-	-	0.8	_	0.8	
V _{OH}	High-Level Output	$V_{IN} = V_{IH} \text{ or } V_{IL}$							V
	Voltage	I _{OH} = -100 μA	0.9	_	V _{CC} - 0.1	-	-	-	
		l F	1.1 to 1.3	$V_{CC}-0.1$	-	-	$V_{CC}-0.1$	-	
			1.4 to 1.6	$V_{CC} - 0.1$	-	-	V _{CC} - 0.1	-	
			1.65 to 1.95	$V_{CC} - 0.2$	-	-	$V_{CC} - 0.2$	-	
			2.3 to <2.7	$V_{CC}-0.2$	-	-	$V_{CC}-0.2$	-	
			2.7 to 3.6	$V_{CC} - 0.2$	-	-	$V_{CC} - 0.2$	-	
		$I_{OH} = -2 \text{ mA}$	1.1 o 1.3	$0.75 \times V_{CC}$	-	-	$0.75 \times V_{CC}$	-	
		I _{OH} = -4 mA	1.4 to 1.6	$0.75 \times V_{CC}$	-	-	$0.75 \times V_{CC}$	-	
	I _{OH} = -6 mA	1.65 to 1.95	1.25	-	-	1.25	-		
		2.3 to <2.7	2.0	-	-	2.0	-		
		I _{OH} = -12 mA	2.3 to <2.7	1.8	-	-	1.8	-	
		2.7 to	2.7 to 3.6	2.2	-	-	2.2	-	
		I _{OH} = -18 mA	2.3 to <2.7	1.7	-	-	1.7	-	
			2.7 to 3.6	2.4	-	-	2.4	-	
		I _{OH} = -24 mA	2.7 to 3.6	2.2	-	-	2.2	-	

DC ELECTRICAL CHARACTERISTICS (continued)

				٦	Γ _A = 25°	С	T _A = -40°	C to +85°C	
Symbol	Parameter	Condition	V _{CC} (V)	Min	Тур	Max	Min	Max	Unit
V _{OL}	Low-Level	$V_{IN} = V_{IH} \text{ or } V_{IL}$							V
	Output Voltage	I _{OL} = 100 μA	0.9	-	0.1	-	-	-	
			1.1 to 1.3	-	-	0.1	-	0.1	
			1.4 to 1.6	-	-	0.1	-	0.1	
			1.65 to 1.95	-	-	0.2	I	0.2	
			2.3 to < 2.7	-	-	0.2	-	0.2	
			2.7 to 3.6	-	-	0.2	-	0.2	
		I _{OL} = 2 mA	1.1 o 1.3	-	-	$0.25 \times V_{CC}$	-	$0.25 \times V_{CC}$	
		I _{OL} = 4 mA	1.4 to 1.6	-	-	$0.25 \times V_{CC}$	-	$0.25 \times V_{CC}$	
		I _{OL} = 6 mA	1.65 to 1.95	-	-	0.3	-	0.3	
		I _{OL} = 12 mA	2.3 to <2.7	-	-	0.4	-	0.4	
			2.7 to 3.6	-	-	0.4	-	0.4	
		I _{OL} = 18 mA	2.3 to <2.7	-	-	0.6	-	0.6	
			2.7 to 3.6	-	-	0.4	-	0.4	
		I _{OL} = 24 mA	2.7 to 3.6	-	-	0.55	-	0.55	
I _{IN}	Input Leakage Current	$V_{IN} = 0 V \text{ to } 3.6 V$	0.9 to 3.6	-	-	±0.1	-	±0.5	μA
I _{OFF}	Power Off Leakage Current	$V_{IN} = 0 V \text{ to } 3.6 V \text{ or}$ $V_{OUT} = 0 V \text{ to } 3.6 V$	0	_	-	0.5	-	0.5	μΑ
Icc	Quiescent Supply Current	$V_{IN} = V_{CC}$ or GND	0.9 to 3.6	_	-	0.9	-	0.9	μA

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

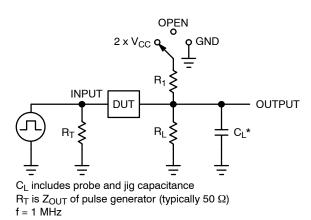
AC ELECTRICAL CHARACTERISTICS

				٦	T _A = 25°C		T _A = -40°C		
Symbol	Parameter	Condition	V _{CC} (V)	Min	Тур	Max	Min	Мах	Unit
t _{PLH} ,	(A or D or C) to V	R_L = 1 MΩ, C_L = 15 pF	0.9	-	14.4	-	-	-	ns
t _{PHL}		R_L = 2 k Ω , C_L = 15 pF	1.1 to 1.3	-	5.0	17.0	-	19.2	
			1.4 to 1.6	-	3.2	10.2	-	12.0	
		R_L = 500 Ω , C_L = 30 pF	1.65 to 1.95	-	2.7	7.8	-	9.2	
			2.3 to 2.7	-	2.0	5.2	-	5.9	
			2.7 to 3.6	-	1.7	4.5	_	4.8	

CAPACITIVE CHARACTERISTICS

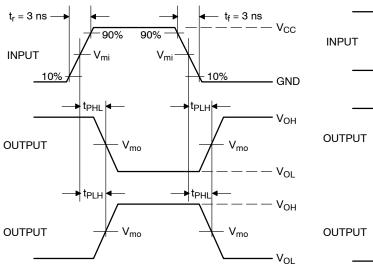
Symbol	Parameter	Test Condition	Typical (T _A = 25°C)	Unit
C _{IN}	Input Capacitance	$V_{CC} = 0 V$	2.0	pF
C _{OUT}	Output Capacitance	V _{CC} = 0 V	4.5	pF
C _{PD}	Power Dissipation Capacitance (Note 5)	f = 10 MHz, V_{CC} = 0.9 to 3.6 V, V _{IN} = 0 V or V _{CC}	8.0	pF

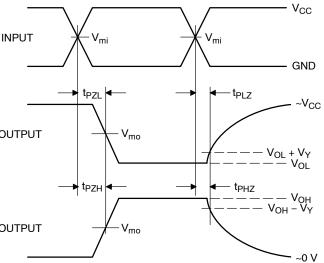
5. C_{PD} is defined as the value of the internal equivalent capacitance which is calculated from the operating current consumption without load. Average operating current can be obtained by the equation $I_{CC(OPR)} = C_{PD} \bullet V_{CC} \bullet f_{in} + I_{CC}$. C_{PD} is used to determine the no-load dynamic power consumption: $P_D = C_{PD} \bullet V_{CC}^2 \bullet f_{in} + I_{CC} \bullet V_{CC}$.



Test	Switch Position
t _{PLH} / t _{PHL}	Open
t _{PLZ} / t _{PZL}	2 x V _{CC}
t _{PHZ} / t _{PZH}	GND

Figure 3. Test Circuit





V _{CC} , V	V _{mi} , V	V _{mo} , V	V _Y , V
0.9	V _{CC} / 2	V _{CC} / 2	0.1
1.1 to 1.3	V _{CC} / 2	V _{CC} / 2	0.1
1.4 to 1.6	V _{CC} / 2	V _{CC} / 2	0.1
1.65 to 1.95	V _{CC} / 2	V _{CC} / 2	0.15
2.3 to 2.7	V _{CC} / 2	V _{CC} / 2	0.15
3.0 to 3.6	1.5	1.5	0.3

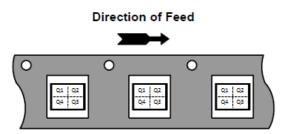
Figure 4. Switching Waveforms

ORDERING INFORMATION

Device	Package	Marking	Pin 1 Orientation (See below)	Shipping [†]
NC7SV11P6X	SC-88	V11	Q4	3000 / Tape & Reel
NC7SV11L6X	MicroPak	AT	Q4	5000 / Tape & Reel

+For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

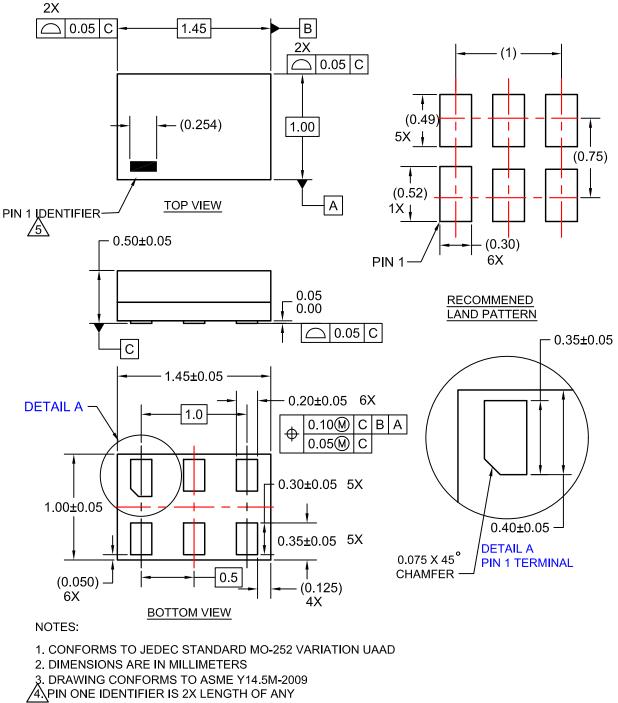
Pin 1 Orientation in Tape and Reel



MicroPak is trademark of Semiconductor Components Industries, LLC (SCILLC) or its subsidiaries in the United States and/or other countries.

PACKAGE DIMENSIONS

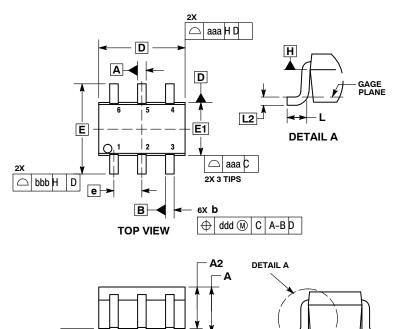
SIP6 1.45X1.0 CASE 127EB ISSUE O



OTHER LINE IN THE MARK CODE LAYOUT.

PACKAGE DIMENSIONS

SC-88/SC70-6/SOT-363 CASE 419B-02 **ISSUE Y**



NOTES:

С

END VIEW

- 1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994. CONTROLLING DIMENSION: MILLIMETERS.
- DIMENSIONS D AND E 1 DO NOT INCLUME TERS. DIMENSIONS D AND E 1 DO NOT INCLUDE MOLD FLASH, PROTRUSIONS, OR GATE BURRS. MOLD FLASH, PROTRU-SIONS, OR GATE BURRS SHALL NOT EXCEED 0.20 PER END. DIMENSIONS D AND E1 AT THE OUTERMOST EXTREMES OF THE PLASTIC BODY AND DATUM H. DATUMS A AND B ARE DETERMINED AT DATUM H. З.

- DIMENSIONS & AND c APPLY TO THE FLAT SECTION OF THE LEAD BETWEEN 0.08 AND 0.15 FROM THE TIP.
- LEAD DET WEEN 0.08 AND 0.15 FROM THE TIF. DIMENSION & DOES NOT INCLUDE DAMBAR PROTRUSION. ALLOWABLE DAMBAR PROTRUSION SHALL BE 0.08 TOTAL IN EXCESS OF DIMENSION & AT MAXIMUM MATERIAL CONDI-TION. THE DAMBAR CANNOT BE LOCATED ON THE LOWER RADIUS OF THE FOOT.

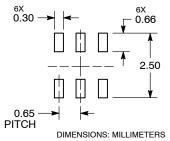
		MILLIMETERS			INCHES				
A1 0.00 0.10 0.000 0.04 A2 0.70 0.90 1.00 0.027 0.035 0.039 b 0.15 0.20 0.25 0.006 0.008 0.010 C 0.08 0.15 0.22 0.003 0.006 0.009 D 1.80 2.00 2.20 0.070 0.78 0.086 E 2.00 2.10 2.20 0.078 0.082 0.086 E1 1.15 1.25 1.35 0.045 0.049 0.053 e 0.65 BSC 0.026 BSC 0.26 BSC L 0.16 BSC 0.006 BSC L 0.15 SC 0.006 BSC 0.006 BSC 0.006 0.006 0.006 0.006 0.006 0.006 0.006 0.006 0.006 0.012 0.012 0.012 0.012 0.012 0.012 0.012 0.012 0.012 0.012 0.012 0.012 0.012 0.012 <td< th=""><th>DIM</th><th>MIN</th><th>NOM</th><th>MAX</th><th>MIN</th><th>NOM</th><th>MAX</th></td<>	DIM	MIN	NOM	MAX	MIN	NOM	MAX		
A2 0.70 0.90 1.00 0.027 0.035 0.039 b 0.15 0.20 0.25 0.006 0.008 0.010 C 0.08 0.15 0.22 0.003 0.006 0.009 D 1.80 2.00 2.20 0.070 0.078 0.086 E 2.00 2.10 2.20 0.078 0.082 0.086 E1 1.15 1.25 1.35 0.045 0.049 0.053 e 0.65 BSC 0.026 BSC 0.026 BSC L 0.26 0.36 0.46 0.010 0.014 0.018 L2 0.15 0.006 BSC 0.006 BSC aaa 0.15 0.006 S006 0.012	Α			1.10			0.043		
b 0.15 0.20 0.25 0.006 0.008 0.010 C 0.08 0.15 0.22 0.003 0.006 0.009 D 1.80 2.00 2.20 0.070 0.078 0.086 E 2.00 2.10 2.20 0.078 0.086 0.010 E1 1.15 1.25 1.35 0.045 0.049 0.053 e 0.65 BSC 0.026 BSC 0.006 BSC L 0.26 0.38 0.46 0.010 0.014 0.018 L2 0.15 SSC 0.006 BSC 0.006 bbb 0.30 0.012 0.012 0.012	A1	0.00		- 0.10	0.000		0.004		
C 0.08 0.15 0.22 0.003 0.006 0.009 D 1.80 2.00 2.20 0.070 0.078 0.086 E 2.00 2.10 2.20 0.078 0.086 0.086 E1 1.15 1.25 1.35 0.045 0.049 0.053 e 0.65 BSC 0.026 BSC L 0.26 0.36 0.46 0.010 0.014 0.018 L2 0.15 SC 0.006 BSC aaa 0.15 0.006 Bbb 0.30 0.012	A2	0.70	0.90	1.00	0.027	0.035	0.039		
D 1.80 2.00 2.20 0.070 0.078 0.086 E 2.00 2.10 2.20 0.078 0.082 0.086 E1 1.15 1.25 1.35 0.045 0.049 0.053 e 0.65 BSC 0.026 BSC 1.25 0.14 0.018 L 0.26 0.36 0.46 0.010 0.014 0.018 L2 0.15 0.006 BSC 0.006 BSC aaa 0.15 0.006 0.012 0.012	b	0.15	0.20	0.25	0.006	0.008	0.010		
E 2.00 2.10 2.20 0.078 0.082 0.086 E1 1.15 1.25 1.35 0.045 0.049 0.053 e 0.65 BSC 0.026 BSC 0.026 BSC L 0.26 0.36 0.46 0.010 0.014 0.018 L2 0.15 BSC 0.006 BSC aa 0.15 0.006 0.012	С	0.08	0.15	0.22	0.003	0.006	0.009		
E1 1.15 1.25 1.35 0.045 0.049 0.053 e 0.65 BSC 0.026 BSC L 0.26 0.36 0.46 0.010 0.014 0.018 L2 0.15 BSC 0.006 BSC 0.006 BSC 0.006 Bbb 0.30 0.012	D	1.80	2.00	2.20	0.070	0.078	0.086		
e 0.65 BSC 0.026 BSC L 0.26 0.36 0.46 0.010 0.014 0.018 L2 0.15 BSC 0.006 BSC 0.006 0.006 0.006 bbb 0.30 0.012 0.012 0.012	Е	2.00	2.10	2.20	0.078	0.082	0.086		
L 0.26 0.36 0.46 0.010 0.014 0.018 L2 0.15 BSC 0.006 BSC 0.006 0.015 0.006 bbb 0.30 0.012 0.012 0.012	E1	1.15 1.25 1.35			0.045	0.049	0.053		
L2 0.15 BSC 0.006 BSC aaa 0.15 0.006 bbb 0.30 0.012	е		0.65 BS	С	0.026 BSC				
aaa 0.15 0.006 bbb 0.30 0.012	Г	0.26	0.36	0.46	0.010 0.014 0.01				
bbb 0.30 0.012	L2	0.15 BSC			0.006 BSC				
	aaa	0.15				0.006			
0 10 0 004	bbb	0.30			0.012				
0.10 0.004	ccc	0.10			0.004				
ddd 0.10 0.004	ddd		0.10			0.004			

RECOMMENDED SOLDERING FOOTPRINT*

A1

SIDE VIEW

SEATING PLANE С



*For additional information on our Pb - Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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